

Bill of Materials

TI DESIGNS

TIDA-00862

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer	PCB Footprint	
					ivialiulacturer	Part Number		
1	1	PCB		Printed Circuit Board	Any			
2	5	C1, C5, C7, C8, C9	0.1uF	CAP, CERM, 0.1uF, 25V, +/-10%	AVX	06033D104KAT2A		603
3		C10, C11		CAP, CERM, 2200pF, 50V, +/-10%	AVX	06035C222KAT2A		603
4	1	C2	22uF	CAP, 22uF	Any	Any		7343
5	1	C3	10uF	CAP, 10uF	Any	Any		805
6	1	C4	1uF	CAP, 1uF	Any	Any		1206
7	1	C6	0.01uF	CAP, 0.01uF	Any	Any		1206
8	3	R2, R6, R12	1k Ohm	RES, 1k ohm, 1%, 0.1W	Vishay-Dale	CRCW06031K00FKEA		603
9	1	R1	4.5k Ohm	RES, 4.5k ohm, 1%, 0.1W	Vishay-Dale	CRCW06034K53FKEA		603
10	1	R5	120 Ohm	RES, 120 ohm, 1%, 0.1W	Vishay-Dale	CRCW0603120RFKEA		603
11	3	R4, R8, R11	N/A	Uninstalled Resistor	N/A	N/A		603
12	4	R3, R7, R9, R10	30 Ohm	RES, 30 ohm, 1%, 0.1W	Vishay-Dale	CRCW060330R0FKEA		603
13	1	D1	Red	Red SM LED	Any	Any		805
14	1	D2	Blue	Blue SM LED	Any	Any		805
15	1	D3	Green	Green SM LED	Any	Any		805
16	2	P1, P2		Connector, Banana Jack, Uninsulated	Pomona	3267	0.500 dia. Inch	
17	9	JMP1, JMP2, JMP3, JMP4, JMP6, JMP7, JMP8, JMP11, JMP12		Header, 100mil, 3x1, Tin, TH	Sullins Connector Solutions	PEC03SAAN	Header, 3 PIN, 100mil, Tin	
18	1	JMP5		Header, 100mil, 4x1, Tin, TH	Sullins Connector Solutions	PEC04SAAN	Header, 4 PIN, 100mil, Tin	
19		JMP9, JMP10, JMP13		Header, 100mil, 2x1, Tin, TH	Sullins Connector Solutions	PEC02SAAN	Header, 2 PIN, 100mil, Tin	
20		TB1		AMP Connector	TE Connectivity	282834-3		200
21		U1		Low-Power RS-485 Full-Duplex Driver/Receiver	Texas Instruments	SN65HVD3806E	14 Pin SOIC	
22		U2		Sympol Transceiver	Texas Instruments	0.100.11200	8 Pin SOIC	
23		U3		Single Inverter	Texas Instruments	SN74LVC1G04	5 Pin SOT-23	
24		U4		Configurable Multiple-Function Gate	Texas Instruments		6 Pin SOT-23	
25		H1, H2, H3, H4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	B&F Fastener Supply		Screw	
26	4	H5, H6, H7, H8		Standoff, Hex, 0.5"L #4-40 Nylon	Keystone	1902C	Standoff	

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design. TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have *not* been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.